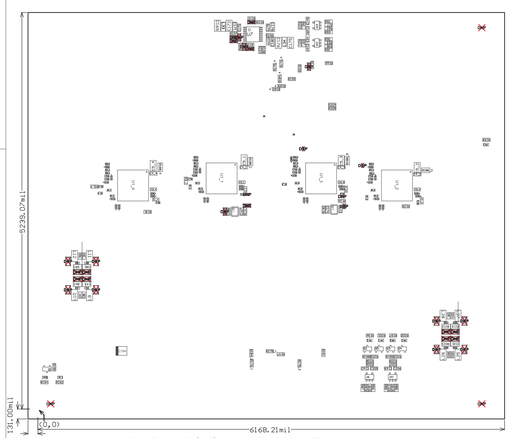
ZZ1 ■ These assemblies MaRe ESD sensitive, ESD precautions shall be observed.
ZZ2 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
ZZ3 ■ These assemblies must comply with workmanship standMaRds IPC-A-610 Class 2, unless otherwise specified.
ZZ4 ■ R136/R140 require special attention due to no solder-mask RF construction. For any questions, please contact TI design team.



131.00mil

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PROC054	REV: D	SVN REV: Not In VersionControl
M3 Board Dimensions			
PLOT NAME = Top Assembly Drawing	GENERATED : 2/11/2020 7:20:37 AM		TEXAS INSTRUMENTS

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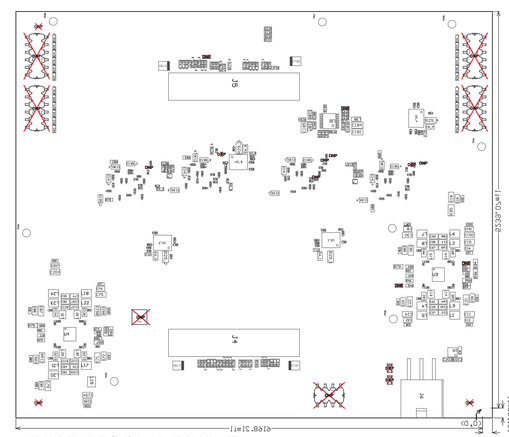
Texas Instruments

PROJECT TITLE: MMWCAS-RF-EVM	
DESIGNED FOR: Public Release	
FILE NAME: PROC054D_MMWCAS_RF_EVM.PcbDoc	
ENGINEER: a0271760	LAYOUT BY: Tessolve:TI
SCALE: 1.00	ALTIUM DESIGNER VERSION: 17.1.5.472

WO#307308-7306-D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